

**SV-SMT 7.62HP/02/90SF 2.6SN BK RL****Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

**Product image**

Similar to illustration

**OMNIMATE Power BV / SV 7.62HP – the 28 kVA performance class****Tailor-made solutions for high performers**

More power reserves for higher load bearing capacity:  
The OMNIMATE Power BV / SV 7.62HP is the middle-class of the power connector systems. It has a large clamping capacity, high overload resistance and the largest range of variants and accessories to choose from: the high performer of the HP range. HP means High Performance – this performance covers a great deal: the full rated current up to 50°C without derating, unlimited 600-V approval according to UL, and the additional finger safety for 400 V-TN systems (+ 3.0 mm) in compliance with the application directive IEC 61800-5-1.

**General ordering data**

Version	PCB plug-in connector, male header, Screw flange, THT/THR solder connection, 7.62 mm, Number of poles: 2, 90°, Solder pin length (l): 2.6 mm, tinned, black, Tape
Order No.	<a href="#">2545810000</a>
Type	SV-SMT 7.62HP/02/90SF 2.6SN BK RL
GTIN (EAN)	4050118555875
Qty.	110 pc(s).
Product data	IEC: 1000 V / 41 A UL: 300 V / 40.5 A
Packaging	Tape

Creation date July 16, 2021 10:58:40 AM CEST

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## Technical data

## Dimensions and weights

Depth	28.3 mm	Depth (inches)	1.114 inch
Height of lowest version	11.4 mm	Net weight	3 g

## Environmental Product Compliance

REACH SVHC	127-19-5 N,N-dimethylacetamide, 541-02-6 Decamethylcyclopentasiloxane, 540-97-6 Dodecamethylcyclohexasiloxane, 556-67-2 Octamethylcyclotetrasiloxane, 84-61-7 Dicyclohexyl phthalate
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## System specifications

Product family	OMNIMATE Power - series BV/SV 7.62HP	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	7.62 mm
Pitch in inches (P)	0.3 inch	Outgoing elbow	90°
Number of poles	2	Number of solder pins per pole	2
Solder pin length (l)	2.6 mm	Solder pin length tolerance	+0.1 / -0.3 mm
Solder pin dimensions	0.8 x 1.0 mm	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerance (D)	+ 0.1 mm	L1 in mm	7.62 mm
L1 in inches	0.3 inch	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	safe to back of hand above the printed circuit board
Touch-safe protection acc. to DIN VDE 0470	IP 20	Volume resistance	2.00 mΩ
Tightening torque for screw flange, min.	0.2 Nm	Tightening torque for screw flange, max.	0.3 Nm
Plugging force/pole, max.	12 N	Pulling force/pole, max.	7 N

## Material data

Insulating material	PA GF HT3	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	I
Comparative Tracking Index (CTI)	≥ 600	Moisture Level (MSL)	3
UL 94 flammability rating	V-0	Contact material	Copper alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 4...6 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 4...6 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	130 °C	Temperature range, installation, min.	-25 °C
Temperature range, installation, max.	130 °C		

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## Technical data

## Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	41 A
Rated current, max. number of poles (Tu=20°C)	41 A	Rated current, min. number of poles (Tu=40°C)	41 A
Rated current, max. number of poles (Tu=40°C)	41 A	Rated voltage for surge voltage class / pollution degree II/2	1,000 V
Rated voltage for surge voltage class / pollution degree III/2	630 V	Rated voltage for surge voltage class / pollution degree III/3	630 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	6 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	6 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	6 kV	Short-time withstand current resistance	3 x 1s with 420 A
Clearance, min.	6.9 mm	Creepage distance, min.	9.6 mm

## Rated data acc. to UL 1059

Institute (cURus)



Certificate No. (cURus)

E60693

Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group C / UL 1059)	300 V
Rated voltage (Use group D / UL 1059)	300 V	Rated current (Use group B / UL 1059)	40.5 A
Rated current (Use group C / UL 1059)	40.5 A	Rated current (Use group D / UL 1059)	10 A
Clearance distance, min.	6.9 mm	Creepage distance, min.	9.6 mm
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

## Packing

Packaging	Tape	VPE length	0
VPE width	0	VPE height	0
Tape depth (T2)	15.8 mm	Tape width (W)	56 mm
Tape pocket depth (K0)	15.3 mm	Tape pocket height (A0)	28.4 mm
Tape pocket width (B0)	39.06 mm	Tape pocket separation (P1)	36 mm
Tape hole separation (E)	1.75 mm	Tape pocket separation (F)	26.2 mm
Tape reel diameter Ø (A)	330 mm	Surface resistance	$R_s = 10^9 - 10^{12} \Omega$

## Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01		

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IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	<ul style="list-style-type: none"><li>• Additional colours on request</li><li>• Rated current related to rated cross-section &amp; min. No. of poles.</li><li>• P on drawing = pitch</li><li>• Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li><li>• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months</li></ul>

**Approvals**

Approvals



UL File Number Search

E60693

**Downloads**

Catalogues

[Catalogues in PDF-format](#)

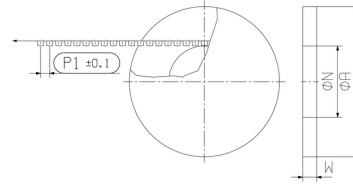
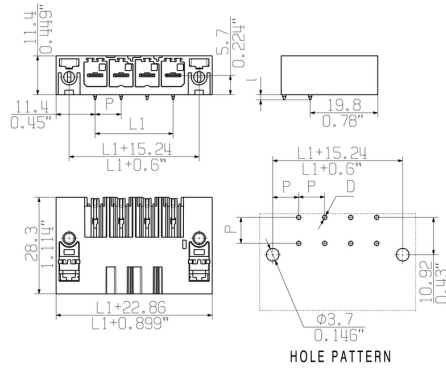
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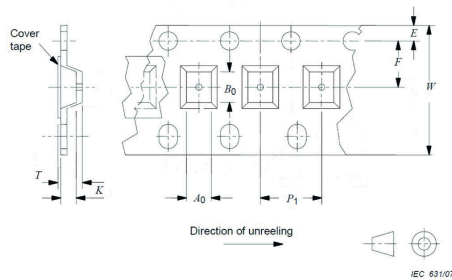
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## Drawings

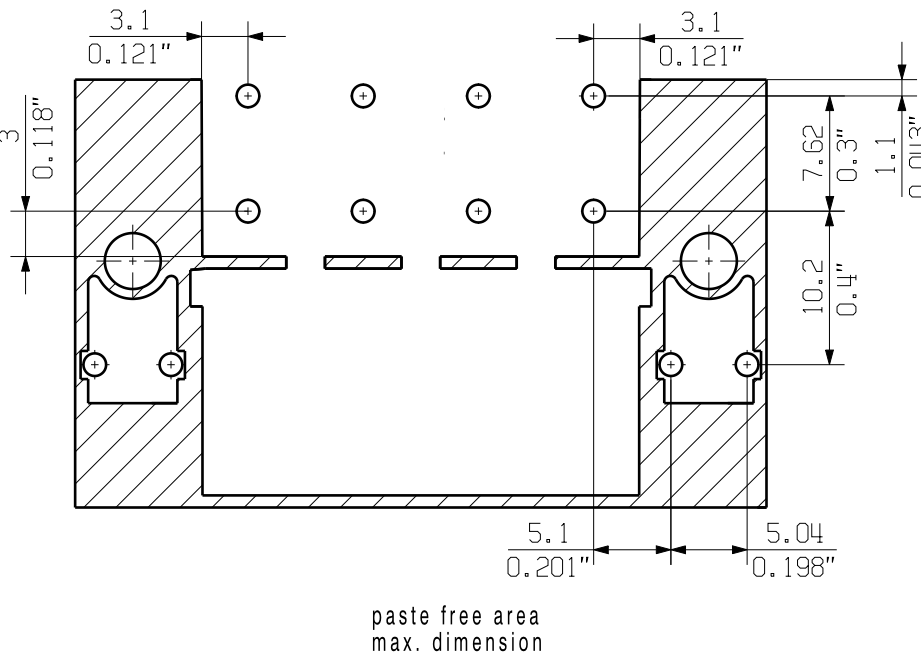
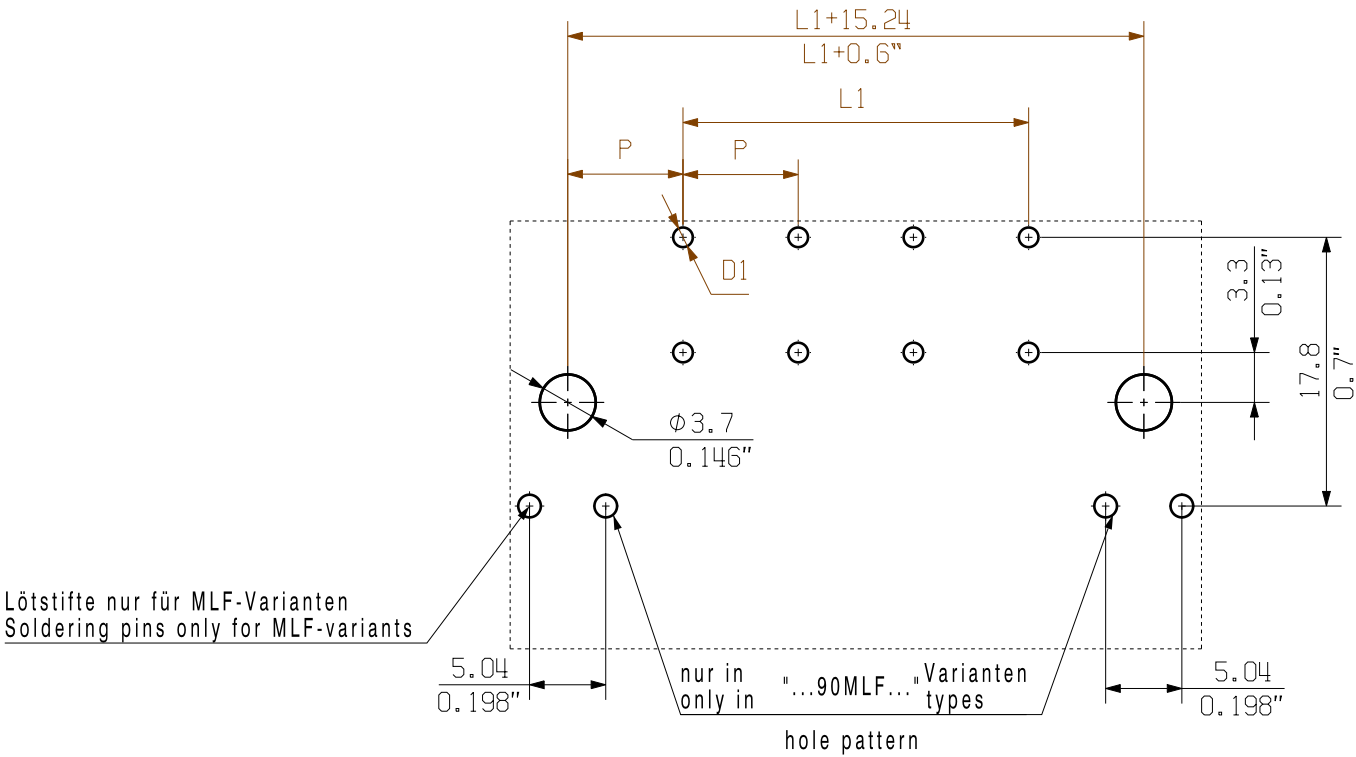
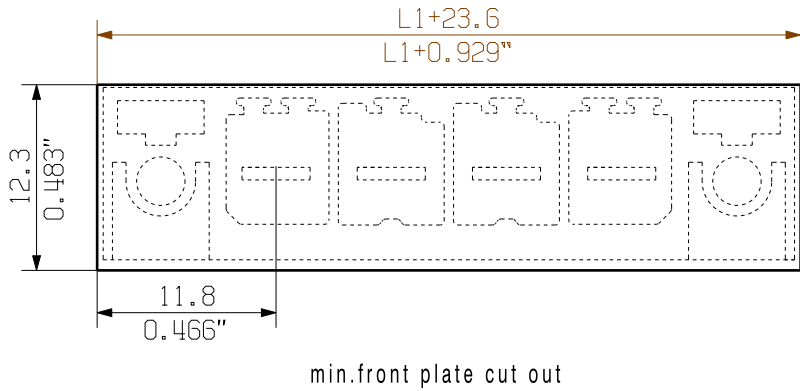
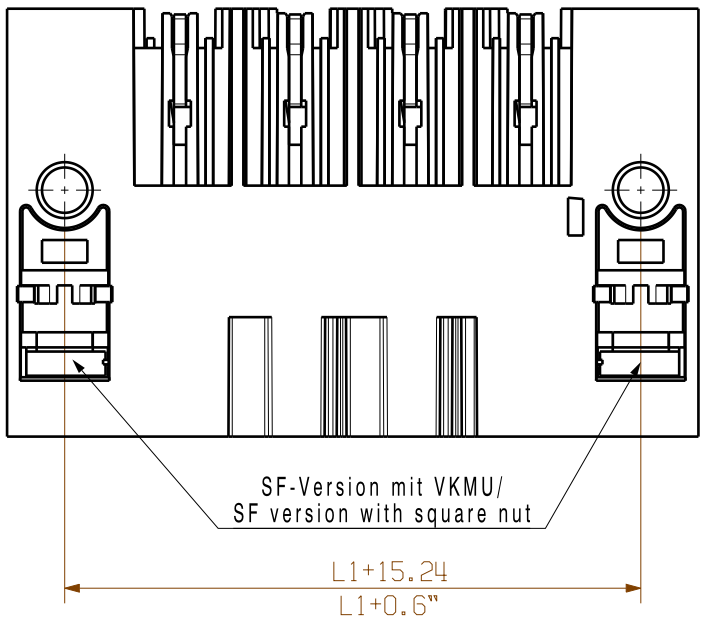
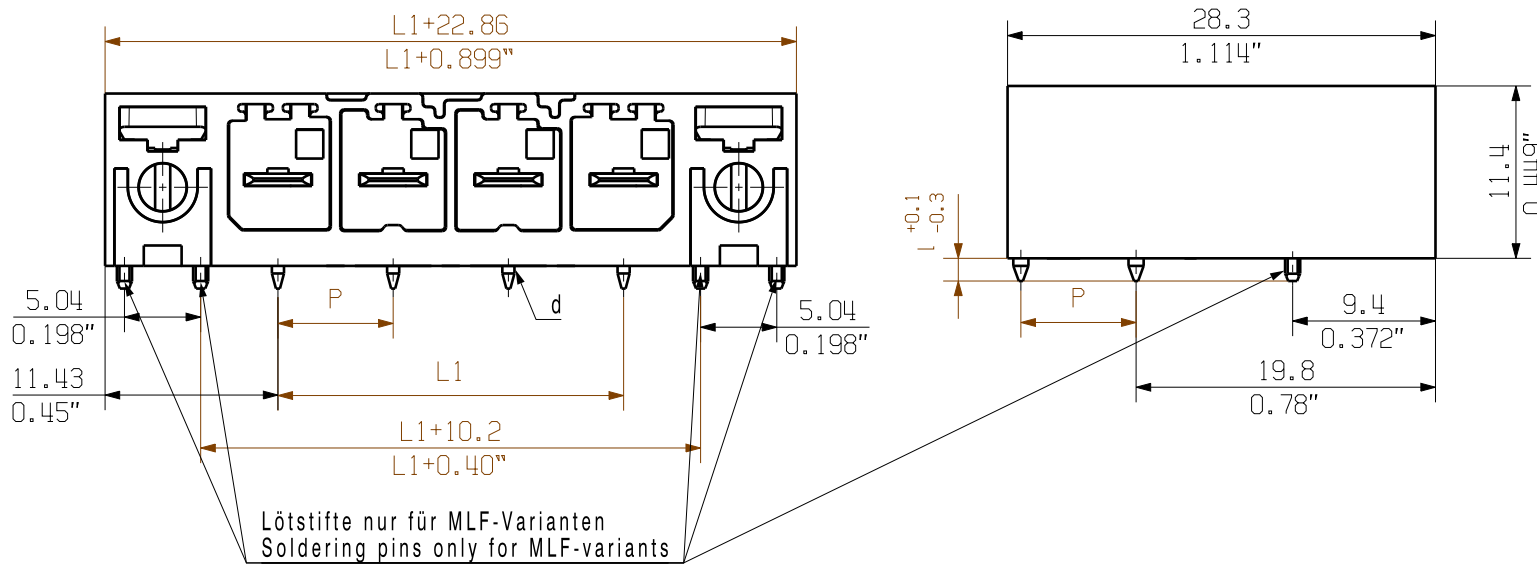
### Dimensional drawing



### Dimensional drawing



SV-SMT 7.62HP/04/90(S/L)F



P = Raster / pitch 7.62

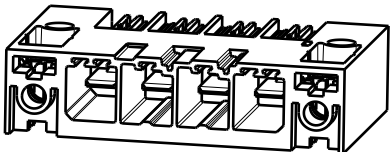
D = Ø1.4+0.1/-0.05

d = 0.8x1.0

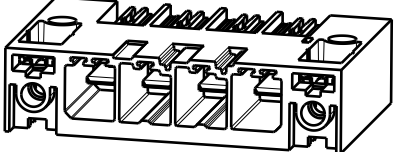
GENERAL TOLERANCE:  
DIN ISO 2768-m

RoHS COMPLIANT	EC00002212	Prim PLM Part No.: 225880		Prim ERP Part No.: 2499550000		
First Issue Date 14.11.2016		Max. nos.	Weidmüller			
Modification		Date	Name	63450		
Drawn		30.08.2019	Helis, Maria	Drawing no. Issue no.		
Responsible		Döhrer, Karl	Sheet 12 of 17 sheets			
Approved		09.10.2019	Lang, Thomas	SV-SMT 7.62HP/IT../90/270...		
Scale: 2:1		Size: A2	STISTLEISTE			
Drawings Assembly		Product file: 7407 BLF 7.50HP			MALE HEADER	

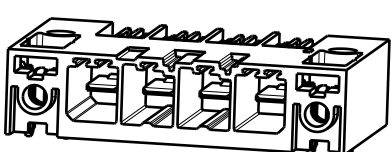
SV-SMT 7.62HP/04/90F



SV-SMT 7.62HP/04/90SF



SV-SMT 7.62HP/04/90LF



For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components alone. The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110. The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

1.5
2.6
3.5
I
[mm]

12	83.82	3.3
11	76.20	3.0
10	68.58	2.7
9	60.96	2.4
8	53.34	2.1
7	45.72	1.8
6	38.10	1.5
5	30.48	1.2
4	22.86	0.9
3	15.24	0.6
2	7.62	0.3
no of poles	L1 [mm]	L1 [inch]

## Recommended wave soldering profiles

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### Single Wave:



### Double Wave:



### Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

## Recommended reflow soldering profile

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### Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3\text{K/s}$ . In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq -6\text{K/s}$  solder is cured. Board and components cool down while avoiding cold cracks.